



SPECIFICATION (Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL03C101JA3ANNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 100pF, 25V, ±5%, C0G, 0201

A. Samsung Part Number

<u>CL</u> <u>03</u> <u>C</u> <u>101</u> <u>J</u> <u>A</u> <u>3</u> <u>A</u> <u>N</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0201 (inch code)	L: 0.6 ± 0.03 mm	W: $0.3 \pm 0.03 \text{ mm}$
③ Dielectric	COG	8 Inner electrode	Pd
Capacitance	100 pF	Termination	Ag
⑤ Capacitance	±5 %	Plating	Sn 100% (Pb Free)
tolerance		Product	Normal
6 Rated Voltage	25 V	Special	Reserved for future use
7 Thickness	0.3 ± 0.03 mm	① Packaging	Cardboard Type, 7" reel

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition	
Capacitance	Within specified tolerance	1th±10% 0.5~5Vrms	
Q	1000 min		
Insulation	More than 500Mohm⋅μF	Rated Voltage 60~120 sec.	
Resistance			
Appearance	No abnormal exterior appearance	Visual inspection	
Withstanding	No dielectric breakdown or	300% of the rated voltage	
Voltage	mechanical breakdown		
Temperature	COG	·	
Characteristics	(From -55℃ to 125℃, Capacitance change should be within ±30PPM/℃)		
Adhesive Strength	No peeling shall be occur on the	200g·F, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change: within ±5%	Bending to the limit (1mm)	
		with 1.0mm/sec.	
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder	
	is to be soldered newly	245±5℃, 3±0.3sec.	
		(preheating: 80~120°C for 10~30sec.)	
Resistance to	Capacitance change: within ±2.5%	Solder pot : 270±5℃, 10±1sec.	
Soldering heat	Tan δ, IR : initial spec.		

	Performance	Test condition
Vibration Test	Capacitance change: within ±2.5%	Amplitude: 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture	Capacitance change: within ±7.5%	With rated voltage
Resistance	Q: 200 min	40±2℃, 90~95%RH, 500 +12/-0 hours
	IR : More than 25MΩ· μF	
High Temperature	Capacitance change : within ±3%	With 200% of the rated voltage
Resistance	Q: 350 min	Max. operating temperature
	IR : More than 50MΩ· μF	1000+48/-0 hours
Temperature	Capacitance change: within ±2.5%	1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}\mathrm{C}$
		5 cycles test

C. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Multilayer Ceramic Capacitors MLCC - SMD/SMT category:

Click to view products by Samsung manufacturer:

Other Similar products are found below:

M39014/01-1467 M39014/02-1218V M39014/02-1225V M39014/02-1262V M39014/02-1301 M39014/22-0631 1210J5000102JCT

1210J2K00102KXT 1210J5000103KXT 1210J5000223KXT D55342E07B379BR-TR D55342E07B523DR-T/R 1812J1K00103KXT

1812J1K00473KXT 1812J2K00680JCT 1812J4K00102MXT 1812J5000102JCT 1812J5000103JCT 1812J5000682JCT NIN-FB391JTRF

NIN-FC2R7JTRF NPIS27H102MTRF C1206C101J1GAC C1608C0G1E472JT000N C2012C0G2A472J 2220J2K00101JCT

KHC201E225M76N0T00 1812J1K00222JCT 1812J2K00102KXT 1812J2K00222KXT 1812J2K00472KXT 2-1622820-7-CUT-TAPE

2220J3K00102KXT 2225J2500824KXT CCR07CG103KM CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C

CGA2B2C0G1H060D CGA2B2C0G1H070D CGA2B2C0G1H151J CGA2B2C0G1H1R5C CGA2B2C0G1H2R2C CGA2B2C0G1H3R3C

CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2X8R1H221K CGA2B2X8R1H472K CGA3E1X7R1C474K

CGA3E2C0G1H561JT0Y0N